

CMPD914E

**ENHANCED SPECIFICATION
SURFACE MOUNT
HIGH SPEED
SILICON SWITCHING DIODE**



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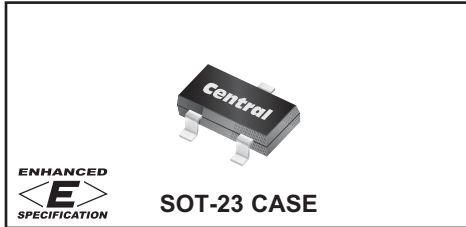
DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD914E is an Enhanced version of the CMPD914 High Speed Switching Diode in a SOT-23 surface mount package, designed for high speed applications.

MARKING CODE: C5DE

FEATURED ENHANCED SPECIFICATIONS:

- ◆ BV_R from 100V min to 120V min. (150V TYP)
- ◆ V_F from 1.0V max to 0.85V max. (0.72V TYP)



MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

Continuous Reverse Voltage	
◆ Peak Repetitive Reverse Voltage	
Continuous Forward Current	
Peak Repetitive Forward Current	
Peak Forward Surge Current, $t_p=1.0\mu\text{s}$	
Peak Forward Surge Current, $t_p=1.0\text{ms}$	
Peak Forward Surge Current, $t_p=1.0\text{s}$	
Power Dissipation	
Operating and Storage Junction Temperature	
Thermal Resistance	

SYMBOL		UNITS
V_R	75	V
V_{RRM}	120	V
I_F	250	mA
I_{FRM}	250	mA
I_{FSM}	4000	mA
I_{FSM}	2000	mA
I_{FSM}	1000	mA
P_D	350	mW
T_J, T_{stg}	-65 to +150	$^\circ\text{C}$
Θ_{JA}	357	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ\text{C}$ unless otherwise noted)

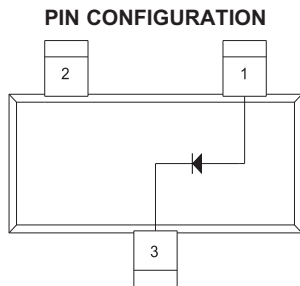
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_R	$V_R=20\text{V}$			25	nA
I_R	$V_R=75\text{V}$			5.0	μA
◆ BV_R	$I_R=100\mu\text{A}$	120	150		V
◆ V_F	$I_F=10\text{mA}$		0.720	0.850	V
◆◆ V_F	$I_F=100\text{mA}$		0.915	0.970	V
C_T	$V_R=0, f=1.0\text{MHz}$			2.0	pF
t_{rr}	$I_R=I_F=10\text{mA}, R_L=100\Omega, \text{Rec. to } 1.0\text{ mA}$			4.0	ns

- ◆ Enhanced specification.
- ◆◆ Additional Enhanced specification.

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SOT-23 CASE - MECHANICAL OUTLINE



LEAD CODE:
 1) Anode
 2) No Connection
 3) Cathode

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SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.003	0.007	0.08	0.18
B	0.006	-	0.15	-
C	-	0.005	-	0.13
D	0.035	0.043	0.89	1.09
E	0.110	0.120	2.80	3.05
F	0.075		1.90	
G	0.037		0.95	
H	0.047	0.055	1.19	1.40
I	0.083	0.098	2.10	2.49
J	0.014	0.020	0.35	0.50

SOT-23 (REV: R3)

R3 (25-January 2010)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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